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August 2015

# MOC3031M, MOC3032M, MOC3033M, MOC3041M, MOC3042M, MOC3043M 6-Pin DIP Zero-Cross Triac Driver Output Optocoupler (250/400 Volt Peak)

Description

consumer appliances, etc.

The MOC303XM and MOC304XM devices consist of a GaAs infrared emitting diode optically coupled to a

monolithic silicon detector performing the function of a

They are designed for use with a triac in the interface of

logic systems to equipment powered from 115 VAC

lines, such as teletypewriters, CRTs, solid-state relays,

industrial controls, printers, motors, solenoids and

zero voltage crossing bilateral triac driver.

## **Features**

- Simplifies Logic Control of 115 VAC Power
- Zero Voltage Crossing
- dv/dt of 2000 V/μs Typical, 1000 V/μs Guaranteed
- Peak Blocking Voltage – 250 V, MOC303XM
  - 400 V, MOC304XM
- Safety and Regulatory Approvals
  - UL1577, 4,170 VAC<sub>RMS</sub> for 1 Minute
  - DIN EN/IEC60747-5-5

#### Applications

- Solenoid/Valve Controls
- Lighting Controls
- Static Power Switches
- AC Motor Drives
- Temperature Controls
- E.M. Contactors
- AC Motor Starters
- Solid State Relays

# **Schematic**

## **Package Outlines** ANODE 1 6 MAIN TERM. 6 CATHODE 2 5 NC\* ZERO N/C 3 CROSSING 4 MAIN TERM. CIRCUIT \*DO NOT CONNECT (TRIAC SUBSTRATE) Figure 1. Schematic Figure 2. Package Outlines

# Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter		Characteristics
Installation Classifications per DIN VDE	< 150 V <sub>RMS</sub>	I–IV
0110/1.89 Table 1, For Rated Mains Voltage	< 300 V <sub>RMS</sub>	I–IV
Climatic Classification		40/85/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V	Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$ , Type and Sample Test with t <sub>m</sub> = 10 s, Partial Discharge < 5 pC	1275	V <sub>peak</sub>
V <sub>PR</sub>	Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	1594	V <sub>peak</sub>
VIORM	Maximum Working Insulation Voltage	850	V <sub>peak</sub>
V <sub>IOTM</sub>	Highest Allowable Over-Voltage	6000	V <sub>peak</sub>
	External Creepage	≥ 7	mm
	External Clearance	≥7	mm
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥ 10	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.5	mm
R <sub>IO</sub>	Insulation Resistance at $T_S$ , $V_{IO}$ = 500 V	> 10 <sup>9</sup>	Ω

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameters	Device	Value	Unit
TOTAL DE	VICE			
T <sub>STG</sub>	Storage Temperature	All	-40 to +150	°C
T <sub>OPR</sub>	Operating Temperature	All	-40 to +85	°C
TJ	Junction Temperature Range	All	-40 to +100	°C
T <sub>SOL</sub>	Lead Solder Temperature	All	260 for 10 seconds	
Р	Total Device Power Dissipation at 25°C Ambient	All	250	mW
PD	Derate Above 25°C	All	2.94	mW/°C
EMITTER				
١ <sub>F</sub>	Continuous Forward Current	All	60	mA
V <sub>R</sub>	Reverse Voltage	All	6	V
р	Total Power Dissipation at 25°C Ambient	All	120	mW
PD	Derate Above 25°C	All	1.41	mW/°C
DETECTO	R			
, v		MOC3031M MOC3032M MOC3033M	250	V
V <sub>DRM</sub>	Off-State Output Terminal Voltage	MOC3041M MOC3042M MOC3043M	400	
I <sub>TSM</sub>	Peak Repetitive Surge Current (PW = 100 µs, 120 pps)	All	1	A
D	Total Power Dissipation at 25°C Ambient	All	150	mW
P <sub>D</sub>	Derate Above 25°C	All	1.76	mW/°C

# **Electrical Characteristics**

 $T_A = 25^{\circ}C$  unless otherwise specified.

#### **Individual Component Characteristics**

Symbol	Parameters	Test Conditions	Device	Min.	Тур.	Max.	Unit
EMITTER					•		
V <sub>F</sub>	Input Forward Voltage	I <sub>F</sub> = 30 mA	All		1.25	1.50	V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> = 6 V	All		0.01	100	μA
DETECTO	DETECTOR						
I <sub>DRM1</sub>	Peak Blocking Current, Either Direction	Rated V <sub>DRM</sub> , $I_F = 0^{(1)}$	All			100	nA
V <sub>TM</sub>	Peak On-State Voltage, Either Direction	$I_{TM} = 100 \text{ mA peak}, I_F = 0$	All		1.8	3.0	V
dv/dt	Critical Rate of Rise of Off-State Voltage	I <sub>F</sub> = 0 (Figure 11) <sup>(2)</sup>	All	1000	2000		V/µs

#### **Transfer Characteristics**

Symbol	DC Characteristics	Test Conditions	Device	Min.	Тур.	Max.	Unit
	I <sub>FT</sub> LED Trigger Current	Current Main Terminal Voltage = 3 V <sup>(3)</sup>	MOC3031M MOC3041M			15	
I <sub>FT</sub>			MOC3032M MOC3042M			10	mA
			MOC3033M MOC3043M			5	
Ι <sub>Η</sub>	Holding Current, Either Direction		All		400		μA

#### **Zero Crossing Characteristics**

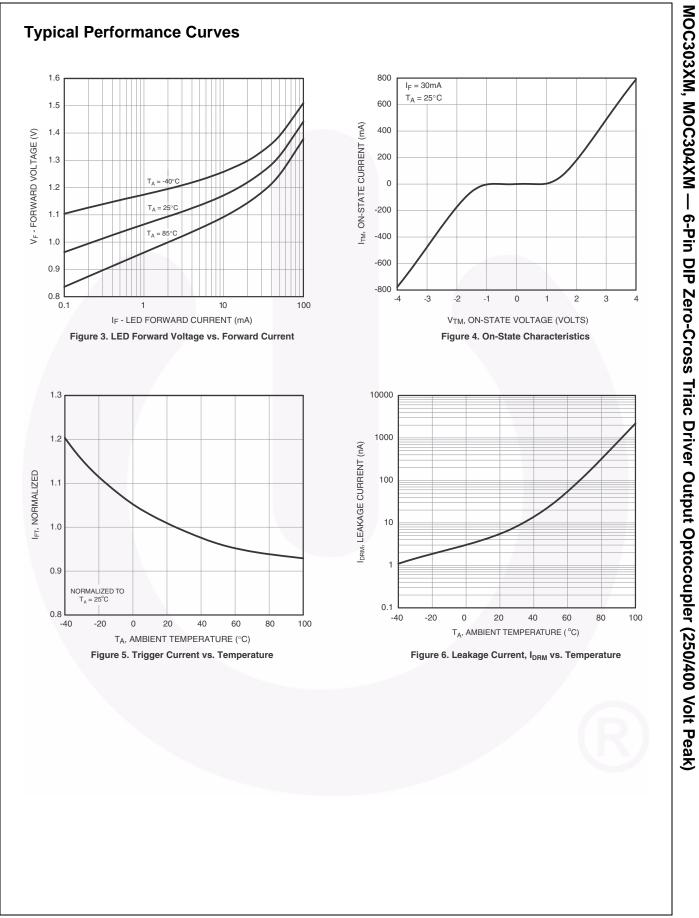
Symbol	Characteristics	Test Conditions	Device	Min.	Тур.	Max.	Unit
V <sub>IH</sub>	Inhibit Voltage	I <sub>F</sub> = rated I <sub>FT</sub> , MT1-MT2 voltage above which device will not trigger off-state	All			20	V
I <sub>DRM2</sub>	Leakage in Inhibited State	$I_F$ = rated $I_{FT}$ , rated $V_{DRM}$ off-state	All			2	mA

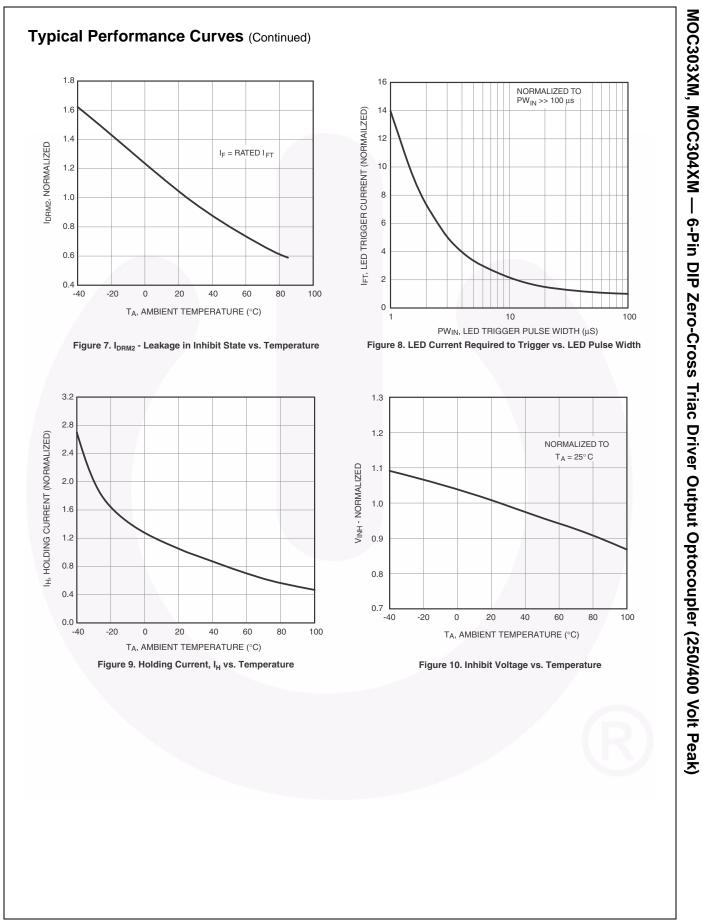
#### **Isolation Characteristics**

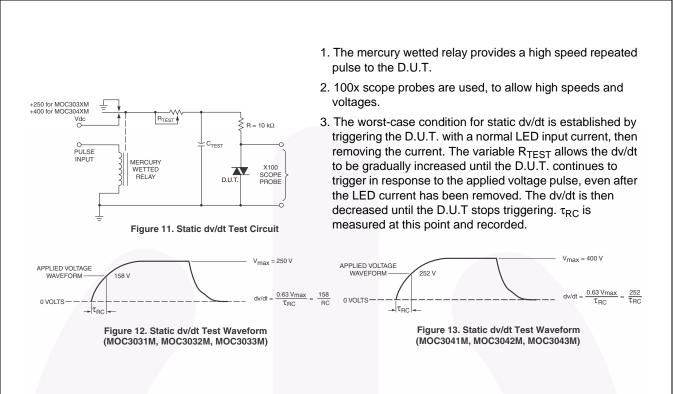
Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
V <sub>ISO</sub>	Isolation Voltage <sup>(4)</sup>	t = 1 Minute	All	4170			VAC <sub>RMS</sub>

#### Notes:

- 1. Test voltage must be applied within dv/dt rating.
- 2. This is static dv/dt. See Figure 11 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.
- All devices are guaranteed to trigger at an I<sub>F</sub> value less than or equal to max I<sub>FT</sub>. Therefore, recommended operating I<sub>F</sub> lies between max I<sub>FT</sub> (15 mA for MOC3031M and MOC3041M, 10 mA for MOC3032M and MOC3042M, 5 mA for MOC3033M and MOC3043M) and absolute maximum I<sub>F</sub> (60 mA).
- 4. Isolation voltage, V<sub>ISO</sub>, is an internal device dielectric breakdown rating. For this test, pins 1 and 2 are common, and pins 4, 5 and 6 are common.

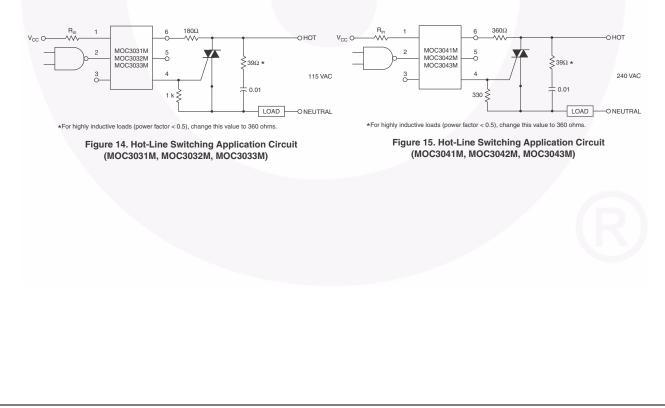


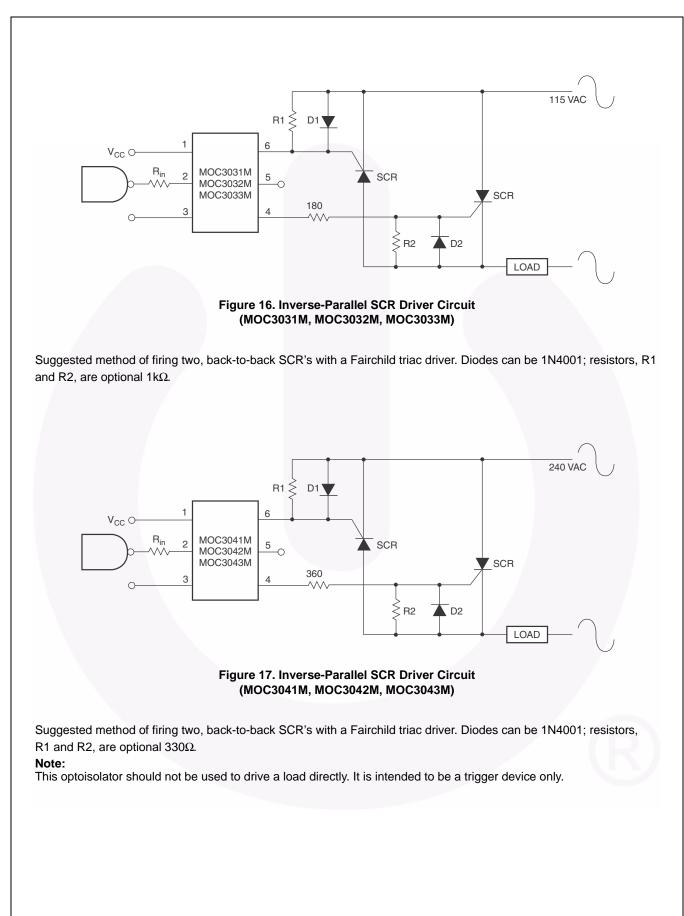


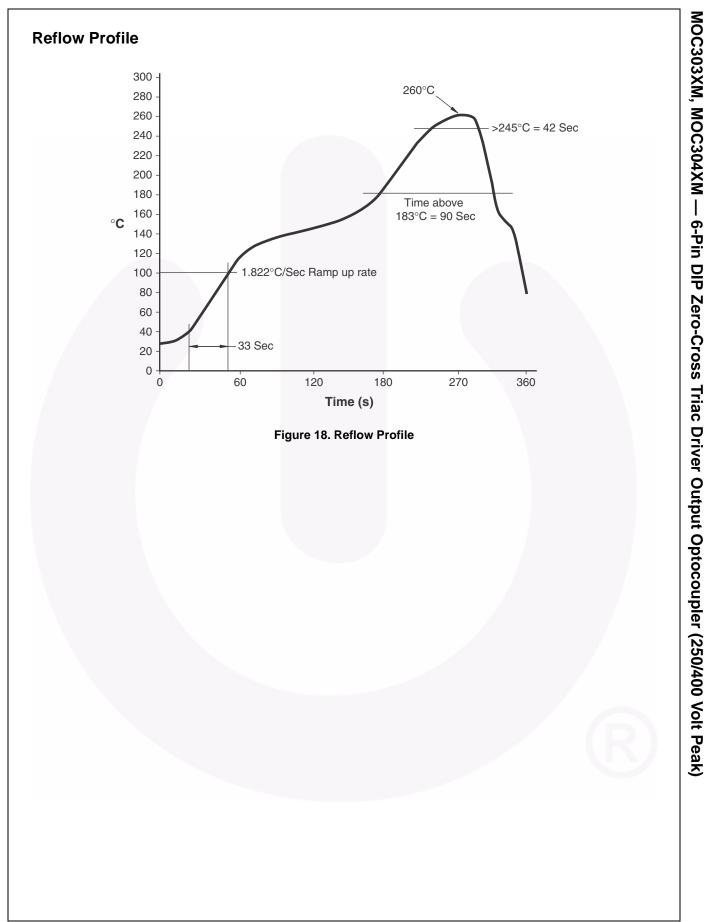


Typical circuit (Fig 14, 15) for use when hot line switching is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.

 $R_{in}$  is calculated so that  $I_F$  is equal to the rated  $I_{FT}$  of the part, 5mA for the MOC3033M and MOC3043M, 10mA for the MOC3032M and MOC3042M, or 15mA for the MOC3031M and MOC3041M. The 39 ohm resistor and 0.01 $\mu F$  capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load used.







# Ordering Information<sup>(5)</sup>

Part Number	Package	Packing Method
MOC3031M	DIP 6-Pin	Tube (50 Units)
MOC3031SM	SMT 6-Pin (Lead Bend)	Tube (50 Units)
MOC3031SR2M	SMT 6-Pin (Lead Bend)	Tape and Reel (1000 Units)
MOC3031VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	Tube (50 Units)
MOC3031SVM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tube (50 Units)
MOC3031SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tape and Reel (1000 Units)
MOC3031TVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	Tube (50 Units)

Note:

5. The product orderable part number system listed in this table also applies to the MOC3032M, MOC3033M, MOC3041M, MOC3042M, and MOC3043M product families.

# **Marking Information**

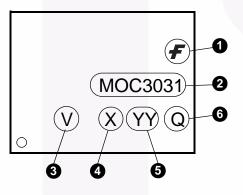


Figure 19. Top Mark

Тор Ма	Top Mark Definitions					
1	Fairchild Logo					
2	Device Number					
3	DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)					
4	One-Digit Year Code, e.g., '5'					
5	Two-Digit Work Week, Ranging from '01' to '53'					
6	Assembly Package Code					











#### NOTES:

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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
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